



SYZ6080 DC Input 800V Photo SCR / Thyristor







Description

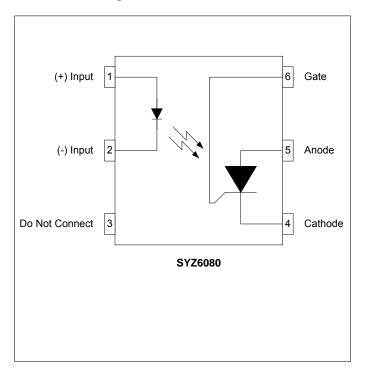
The SYZ6080 consists of a single input AlGaAs LED optically coupled to a photo-sensitive SCR. coupling provides high isolation levels (up to $5kV_{RMS}$) while maintaining low-level DC signal control capability. With high load voltage and low input current, the SYZ6080 is an ideal solution for driving high voltage SCRs, Triacs and Solid State Relays.

The SYZ6080 comes standard in a compact 6 pin DIP package making it ideal for high-density board applications.

Applications

- Home Appliances
- Motor / Drive Controls
- Solid State Relays
- Solenoid / Valve Controls
- **Temperature Controls**
- **Dimmer Controls**

Schematic Diagram



Features

- Low Input Control Current (5mA MAX)
- High Blocking Voltage (800V)
- 400mA Maximum Continuous Current
- High Isolation Voltage (up to 5kV_{RMS})
- High Transient Immunity ($dV/dt = 400V/\mu S MIN$)
- Long Life / High Reliability
- RoHS / Pb-Free / REACH Compliant

Agency Approvals

UL/C-UL: File # E201932

VDE: File # 40035191 (EN 60747-5-2)

Absolute Maximum Ratings

The values indicated are absolute stress ratings. Functional operation of the device is not implied at these or any conditions in excess of those defined in electrical characteristics section of this document. Exposure to absolute Maximum Ratings may cause permanent damage to the device and may adversely affect reliability.

Storage Temperature	55 to +125°C
Operating Temperature	40 to +85°C
Continuous Input Current	50mA
Transient Input Current	400mA
Transient Output Current	10A
Reverse Input Control Voltage	5V
Input Power Dissipation	40mW
Output Power Dissipation	500mW
Solder Temperature – Wave (10sec)	260°C
Solder Temperature - IR Reflow (10sec)	260°C

Ordering Information

	Part Number	Description
;	SYZ6080	6 pin DIP, (60/Tube)
;	SYZ6080-H	5kV _{RMS} V _{ISO} , 6 pin DIP, (60/Tube)
	SYZ6080-S	6 pin SMD, (60/Tube)
;	SYZ6080-HS	5kV _{RMS} , 6 pin SMD, (60/Tube)
;	SYZ6080-STR	6 pin SMD, Tape and Reel (1000/Reel)
;	SYZ6080-HSTR	$5kV_{RMS}$, 6 pin SMD, Tape and Reel (1000/Reel)

NOTE: Suffixes listed above are not included in marking on device for part number identification



Electrical Characteristics, T_A = 25°C (unless otherwise specified)

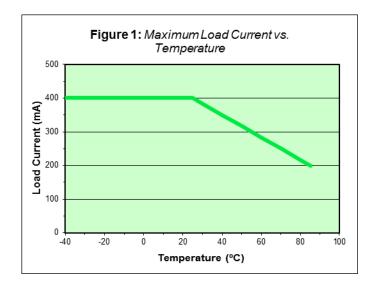
Parameter	Symbol	Min.	Тур.	Max.	Units	Test Conditions	
Input Specifications							
LED Forward Voltage	V _F	-	1.2	1.5	V	I _F = 10mA	
LED Reverse Voltage	BV _R	5	-	-	V	I _R = 10μA	
Reverse Leakage Current	I _{InRleak}	-	-	10	μА	V _R = 5μA	
Trigger (Must Operate) Current ¹	I _{InOn}	-	2.5	5	mA	I _O = 400mA	
Output Specifications							
Forward Blocking Voltage	V _{DM}	800	-	-	V	R_{GK} =10kΩ, T_{A} =100°C, I_{D} =150μA	
Reverse Blocking Voltage	V_{RM}	800	-	-	V	R_{GK} =10kΩ, T_A =100°C, I_R =150μA	
Continuous Load Current	I _{DM}	-	-	400	mA	I _F = 5mA	
Transient Surge Current	I _{DM (PEAK)}	-	-	10	Α	T = 16μS	
On-State Voltage	V _{TM}	-	1.1	1.4	V	I _F = 5mA, I _{DM} = 400mA	
Forward Leakage Current	I _{DM}	-	1	10	μА	R_{GK} =10k Ω , T_A =100°C, V_{DM} =800V, I_F =0	
Reverse Leakage Current	I _{RM}	-	1	10	μА	R _{GK} =10kΩ, T _A =100°C, V _{RM} =800V, I _F =0	
Gate Trigger Voltage	V _{GT}	-	0.6	1	V	V_{FX} =100V, R_{GK} =27k Ω , R_{L} =10k Ω	
Gate Trigger Current	I _{GT}	-	20	50	μА	V_{FX} =100V, R_{GK} =27k Ω , R_{L} =10k Ω	
Critical Rate of Rise ²	dV/dt	400	-	-	V/µS	-	
Isolation Specifications							
Isolation Voltage	V _{ISO}	3750			V	RH ≤ 50%, t=1min	
(-H Option)	VISO	5000	-	-	V _{RMS}	K□ ≥ 50%, t= 1111111	
Input-Output Resistance	R _{I-O}	-	10 ¹²	-	Ω	V _{I-O} = 500V _{DC}	

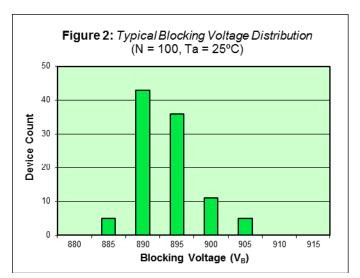
Note 1: Resistive load. For inductive loads, higher drive current is recommended

Note 2: This is for static dV/dt.



SYZ6080 Performance & Characteristics Plots, T_A = 25°C (unless otherwise specified)







SYZ6080 Solder Temperature Profile Recommendations

(1) Infrared Reflow:

Refer to the following figure as an example of an optimal temperature profile for single occurrence infrared reflow. Soldering process should not exceed temperature or time limits expressed herein. Surface temperature of device package should not exceed 250°C:

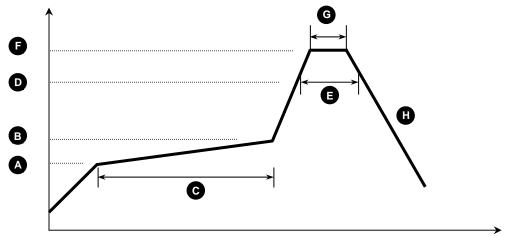


Figure 1

Process Step	Description	Parameter		
Α	Preheat Start Temperature (°C)	150°C		
В	Preheat Finish Temperature (°C)	180°C		
С	Preheat Time (s)	90 - 120s		
D	Melting Temperature (°C)	230°C		
E	Time above Melting Temperature (s)	30s		
F	Peak Temperature, at Terminal (°C)	260°C		
G	Dwell Time at Peak Temperature (s)	10s		
Н	Cool-down (°C/s)	<6°C/s		

(2) Wave Solder:

Maximum Temperature: 260°C (at terminal)

Maximum Time: 10s

Pre-heating: 100 - 150°C (30 - 90s)

Single Occurrence

(3) Hand Solder:

Maximum Temperature: 350°C

Maximum Time:

Single Occurrence

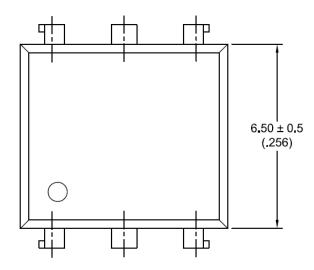
(at tip of soldering iron) 3s

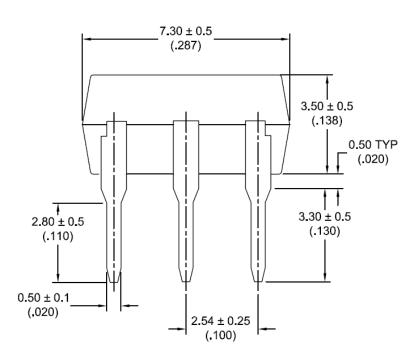


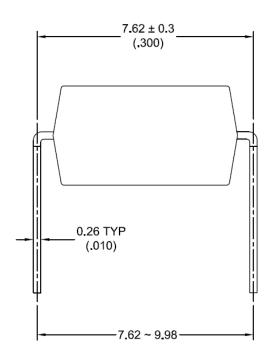
SYZ6080 Package Dimensions

6 PIN DIP Package

Note: All dimensions in millimeters with inches ["] in parenthesis ()





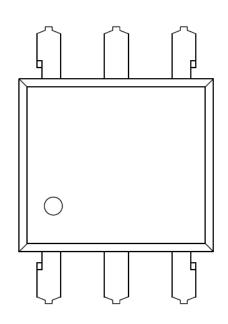


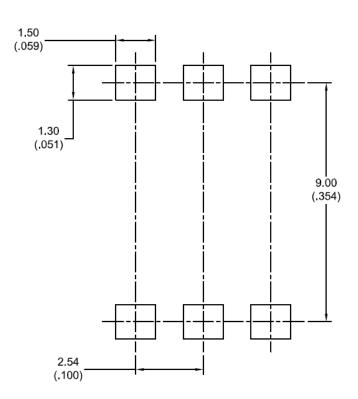


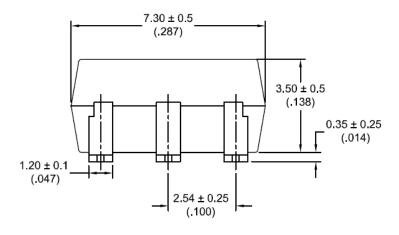
SYZ6080 Package Dimensions

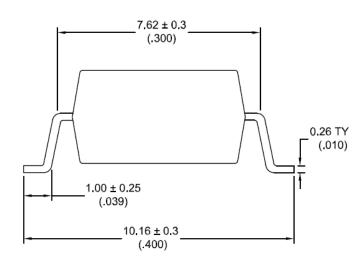
6 PIN SMD Surface Mount Package (-S)

Note: All dimensions in millimeters with inches ["] in parenthesis ()







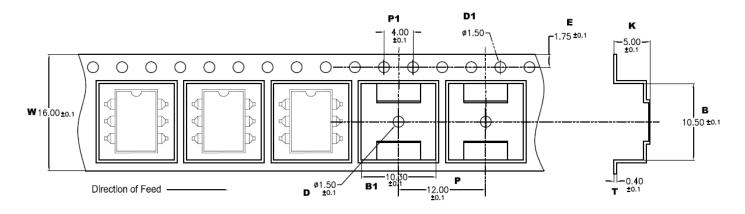




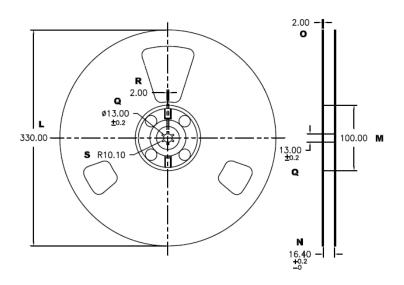
SYZ6080 Package Dimensions

6 PIN SMD Tape & Reel (-STR)

Note: All dimensions in millimeters



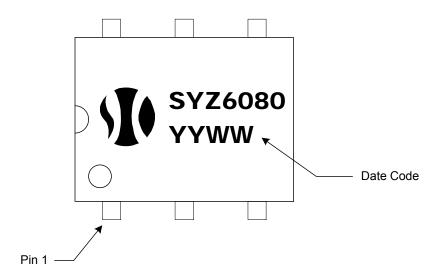
W	В	B1	P	P1	K	Ш	Т	D	D1
16.00 ±0.1	10.50 ±0.1	10.30 ±0.1	12.00 ±0.1	4.00 ±0.1	5.00 ±0.1	1.75 ±0.1	0.40 ±0.1	1.50 ±0.1	1.50 ±0.1



L	М	Z	Q		R	S
330.00	100.00	16.40 +0.2	2.00 ±0.1	13.00 ±0.2	2.00	10.00



SYZ6080 Package Marking



SYZ6080 Package Weights

Device	Single Unit	Full Tube (60pcs)	Full Pouch (10 tubes)	Full Reel (1000pcs)
SYZ6080-(H)	0.41	43	450	-
SYZ6080-(H)S	0.40	42	440	-
SYZ6080-(H)STR	0.40	-	-	880

Note: All weights above are in GRAMS, and include packaging materials where applicable

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